

### 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

## Notification# 20180802003 Datasheet for LSF0108-Q1 Information Only

**Date:** August 08, 2018

To: PREMIER FARNELL PCN

#### Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

# Information Only Attachments

#### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

**DEVICE** LSF0108QPWRQ1 **CUSTOMER PART NUMBER** 

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20180802003		PCN Date:	Aug	August 08, 2018			
Title: Datasheet for LSF0108-Q1									
Custor	mer Contact:	PCN Manager	N Manager			ept:	Quality Services		
Change Type:									
Assembly Site			Design			Wafer Bump Site			
Assembly Process							Wafer Bump Material		
Assembly Materials			Part nur	$\perp \perp$	Wafer Bump Process				
Mechanical Specification			Test Site		Wafer Fab Site				
Packing/Shipping/Labeling		abeling	Test Process				r Fab Materials		
			1 - 1:6: 1		Wafer Fab Process				
Notification Details									
Description of Change:  Toyog Instruments Inserporated is appaulating an information only notification									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.									
The following change history provides further details.									
No. There is									
The state of the s	EXAS NSTRUMENTS						LSF0108-Q1		
SDLS967C –MAY 2016–REVISED JULY 2018									
Changes from Revision B (June 2016) to Revision C Page									
Changed Thermal Information values									
The datasheet number will be changing.									
Device	Device Family		С	Change From:		Chang	e To:		
LSFC	SF0108-Q1		S	SDLS967B		SDLS9	67C		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/LSF0108-Q1									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
LSF0	108QPWRQ1								

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com